



**Spec No.: DS-22-98-0004** Effective Date: 02/16/2005

Revision: A

**LITE-ON DCC** 

**RELEASE** 

BNS-OD-FC001/A4

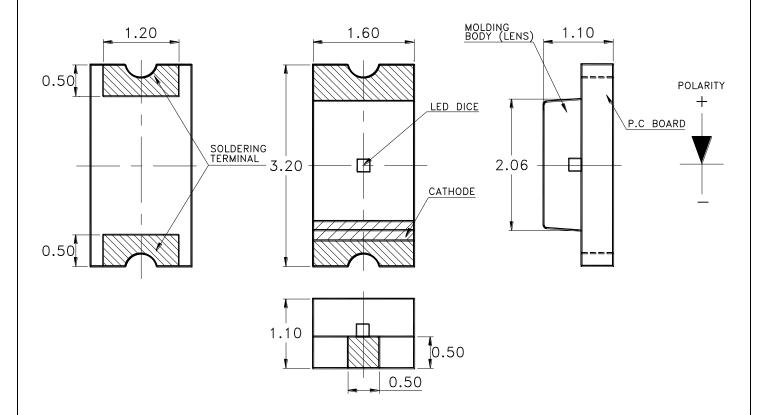


### Property of Lite-On Only

#### **Features**

- \* Meet ROHS, Green Product.
- \* Package In 8mm Tape On 7" Diameter Reels.
- \* Compatible With Automatic Placement Equipment.
- \* Compatible With Infrared And Vapor Phase Reflow Solder Process.
- \* EIA STD package.
- \* I.C. compatible.

#### Package Dimensions



Part No.	Lens	Source Color
LTST-C150GKT	Water Clear	GaP on GaP Green

#### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm~0.10$  mm (.004") unless otherwise noted.

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Absolute Maximum Ratings At Ta=25°C

Parameter	LTST-C150GKT	Unit			
Power Dissipation	100	mW			
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	120	mA			
DC Forward Current	30	mA			
Derating Linear From 50°C	0.6	mA/°C			
Reverse Voltage	5	V			
Operating Temperature Range	-55°C to + 85°C				
Storage Temperature Range	-55°C to +85°C				
Wave Soldering Condition	260°C For 5 Seconds				
Infrared Soldering Condition	260°C For 5 Seconds				
Vapor Phase Soldering Condition	215°C For 3 Minutes				

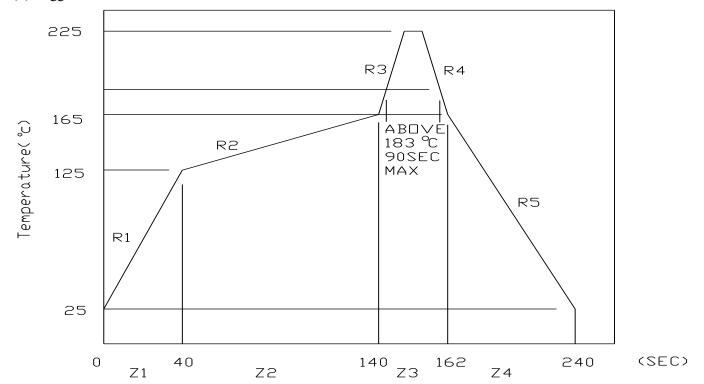
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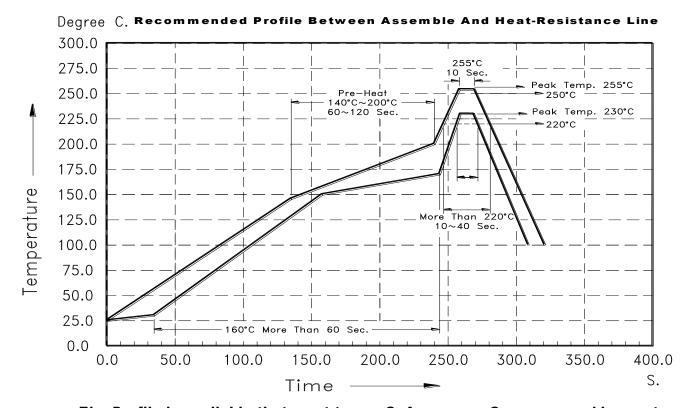
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#### **Suggestion Profile:**

#### (1) Suggestion IR Reflow Profile For Normal Process



#### (2) Suggestion IR Reflow Profile For Pb Free Process



The Profile is available that must to use SnAg  $_{\left(x=3.3\sim3.8\right)}$  Cu  $_{\left(y=0.2\sim0.7\right)}$  solder paste

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#### Property of Lite-On Only

#### Electrical Optical Characteristics At Ta=25°C

Parameter	Symbol	Part No. LTST-	Min.	Тур.	Max.	Unit	Test Condition	
Luminous Intensity	IV	C150GKT	1.8	6.0		mcd	IF = 10mA Note 1	
Viewing Angle	2 θ 1/2	C150GKT		130		deg	Note 2 (Fig.6)	
Peak Emission Wavelength	λΡ	C150GKT		565		nm	Measurement @Peak (Fig.1)	
Dominant Wavelength	λd	C150GKT		569		nm	Note 3	
Spectral Line Half-Width	Δλ	C150GKT		30		nm		
Forward Voltage	VF	C150GKT		2.1	2.6	V	IF = 20mA	
Reverse Current	IR	C150GKT			10	$\mu$ A	VR = 5V	
Capacitance	С	C150GKT		35		PF	VF = 0 f = 1MHZ	

Notes: 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.

- 2.  $\theta$  1/2 is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3. The dominant wavelength,  $\lambda$  d is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.

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### **Bin Code List**

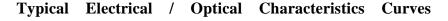
Luminous Inte	ensity Unit:	Unit: mcd @10mA		
Bin Code	Min.	Max.		
G	1.80	2.80		
Н	2.80	4.50		
J	4.50	7.10		
K	7.10	11.2		
L	11.2	18.0		

Tolerance on each Intensity bin is +/-15%

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(25 °C Ambient Temperature Unless Otherwise Noted)

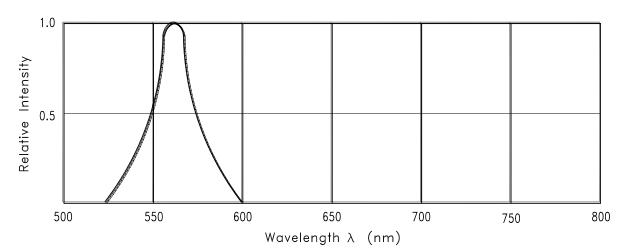


Fig.1 RELATIVE INTENSITY VS. WAVELENGTH

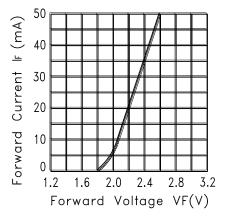


Fig.2 FORWARD CURRENT VS. FORWARD VOLTAGE

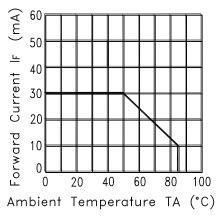


Fig.3 FORWARD CURRENT DERATING CURVE

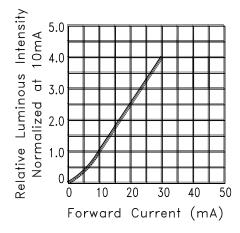


Fig.4 RELATIVE LUMINOUS
INTENSITY VS. FORWARD
CURRENT

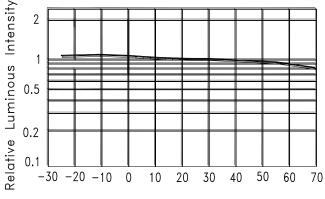


Fig.5 LUMINOUS INTENSITY VS. AMBIENT TEMPERATURE

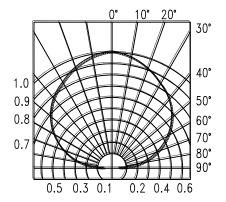


Fig.6 SPATIAL DISTRIBUTION

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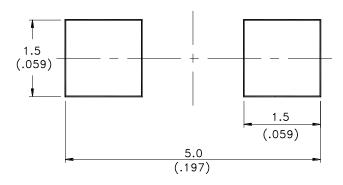
Property of Lite-On Only

#### Cleaning

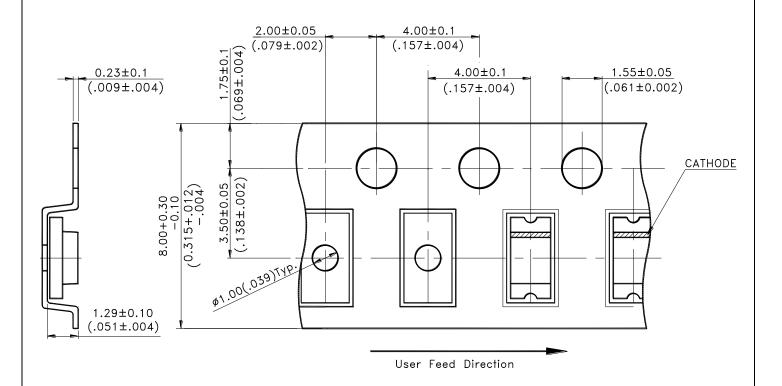
Do not use unspecified chemical liquid to clean LED they could harm the package.

If clean is necessary, immerse the LED in ethyl alcohol or in isopropyl alcohol at normal temperature for less one minute.

#### **Suggest Soldering Pad Dimensions**



#### **Package Dimensions Of Tape And Reel**



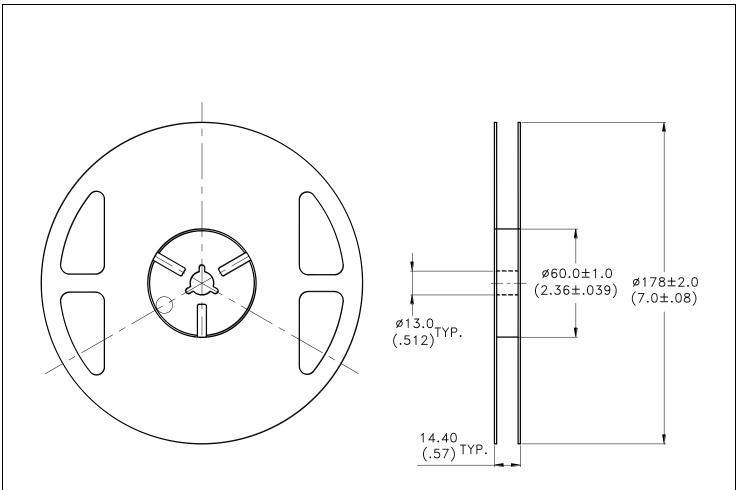
#### Notes:

1. All dimensions are in millimeters (inches).

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#### Notes:

- 1. Empty component pockets sealed with top cover tape.
- 2. 7 inch reel-3000 pieces per reel.
- 3. Minimum packing quantity is 500 pcs for remainders.
- 4. The maximum number of consecutive missing lamps is two.
- 5. In accordance with ANSI/EIA 481-1-A-1994 specifications.

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#### **CAUTIONS**

#### 1. Application

The LEDs described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household applications). Consult Liteon's Sales in advance for information on applications in which exceptional reliability is required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as in aviation, transportation, traffic control equipment, medical and life support systems and safety devices).

#### 2. Storage

The storage ambient for the LEDs should not exceed 30°C temperature or 70% relative humidity. It is recommended that LEDs out of their original packaging are IR-reflowed within one week. For extended storage out of their original packaging, it is recommended that the LEDs be stored in a sealed container with appropriate desiccant, or in a desiccators with nitrogen ambient. LEDs stored out of their original packaging for more than a week should be baked at about 60 deg C for at least 24 hours before solder assembly.

#### 3. Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED if necessary.

#### 4. Soldering

Recommended soldering conditions:

Reflow soldering		Wave So	ldering	Soldering iron		
Pre-heat Pre-heat time Peak temperature Soldering time	120 sec. Max. 240°C Max.		100°C Max. 60 sec. Max. 260°C Max. 10 sec. Max.	1	300°C Max. 3 sec. Max. (one time only)	

#### 5. Drive Method

An LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit A below.



- (A) Recommended circuit.
- (B) The brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs.

#### **6. ESD (Electrostatic Discharge)**

Static Electricity or power surge will damage the LED.

Suggestions to prevent ESD damage:

- Use of a conductive wrist band or anti-electrostatic glove when handling these LEDs.
- All devices, equipment, and machinery must be properly grounded.
- Work tables, storage racks, etc. should be properly grounded.
- Use ion blower to neutralize the static charge which might have built up on surface of the LED's plastic lens as a result of friction between LEDs during storage and handling.

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#### Property of Lite-On Only

ESD-damaged LEDs will exhibit abnormal characteristics such as high reverse leakage current, low forward voltage, or "no lightup" at low currents.

To verify for ESD damage, check for "lightup" and Vf of the suspect LEDs at low currents.

The Vf of "good" LEDs should be >2.0V@0.1mA for InGaN product and >1.4V@0.1mA for AlInGaP product.

#### 7. Reliability Test

Classification	Test Item	Test Condition	Reference Standard
	Operation Life	Ta= Under Room Temperature As Per Data Sheet Maximum Rating *Test Time= 1000HRS (-24HRS,+72HRS)*@20mA.	MIL-STD-750D:1026 MIL-STD-883D:1005 JIS C 7021:B-1
Endurance Test	High Temperature High Humidity Storage	IR-Reflow In-Board, 2 Times Ta= 65±5°C,RH= 90∼95% *Test Time= 240HRS±2HRS	MIL-STD-202F:103B JIS C 7021:B-11
	High Temperature Storage	Ta= 105±5°C *Test Time= 1000HRS (-24HRS,+72HRS)	MIL-STD-883D:1008 JIS C 7021:B-10
	Low Temperature Storage	Ta= -55±5°C *Test Time=1000HRS (-24HRS,+72H RS)	JIS C 7021:B-12
	Temperature Cycling	$105^{\circ}\text{C} \sim 25^{\circ}\text{C} \sim -55^{\circ}\text{C} \sim 25^{\circ}\text{C}$ 30mins 5mins 30mins 5mins 10 Cycles	MIL-STD-202F:107D MIL-STD-750D:1051 MIL-STD-883D:1010 JIS C 7021:A-4
Environmental Test	Thermal Shock	IR-Reflow In-Board, 2 Times $85 \pm 5^{\circ}$ C $\sim -40^{\circ}$ C $\pm 5^{\circ}$ C $\sim 10$ mins 10 Cycles	MIL-STD-202F:107D MIL-STD-750D:1051 MIL-STD-883D:1011
	Solder Resistance	T.sol= $260 \pm 5^{\circ}$ C Dwell Time= $10 \pm 1$ secs	MIL-STD-202F:210A MIL-STD-750D:2031 JIS C 7021:A-1
	IR-Reflow Normal Process	Ramp-up rate( $183^{\circ}$ C to Peak) $+3^{\circ}$ C/ second max Temp. maintain at $125(\pm 25)^{\circ}$ C 120 seconds max Temp. maintain above $183^{\circ}$ C 60-150 seconds Peak temperature range $235^{\circ}$ C+5/-0 $^{\circ}$ C Time within $5^{\circ}$ C of actual Peak Temperature (tp) 10-30 seconds Ramp-down rate $+6^{\circ}$ C/second max	MIL-STD-750D:2031.2 J-STD-020
	IR-Reflow Pb Free Process	Ramp-up rate( $217^{\circ}$ C to Peak) $+3^{\circ}$ C/ second max Temp. maintain at $175(\pm 25)^{\circ}$ C 180 seconds max Temp. maintain above $217^{\circ}$ C 60-150 seconds Peak temperature range $260^{\circ}$ C+0/-5 $^{\circ}$ C Time within 5 $^{\circ}$ C of actual Peak Temperature (tp) 20-40 seconds Ramp-down rate $+6^{\circ}$ C/second max	MIL-STD-750D:2031.2 J-STD-020
	Solderability	T.sol= $235 \pm 5^{\circ}$ C Immersion time $2\pm 0.5$ sec Immersion rate $25\pm 2.5$ mm/sec Coverage $\geq 95\%$ of the dipped surface	MIL-STD-202F:208D MIL-STD-750D:2026 MIL-STD-883D:2003 IEC 68 Part 2-20 JIS C 7021:A-2

#### 8. Others

The appearance and specifications of the product may be modified for improvement without prior notice.

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